N-Channel Power MOSFET

1000V, 1.85A, 8.5Ω

FEATURES

- 100% avalanche tested
- Advanced planar process
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

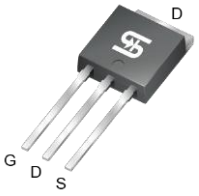
APPLICATIONS

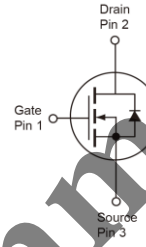
- AC/DC LED Lighting
- Power Supply
- Power Meter

KEY PERFORMANCE PARAMETERS		
PARAMETER	**VALUE**	**UNIT**
V_{DS}	1000	V
$R_{DS(on)}$ (max)	8.5	Ω
Q_g	17	nC

Pb-Free RoHS COMPLIANT HALOGEN FREE

TO-251 (IPAK)





ABSOLUTE MAXIMUM RATINGS (T_A = 25°C unless otherwise noted)

PARAMETER		SYMBOL	Limit	UNIT
Drain-Source Voltage		V_{DS}	1000	V
Gate-Source Voltage		V_{GS}	±30	V
Continuous Drain Current (Note 1)	T_C = 25°C	I_D	1.85	A
	T_C = 100°C		1.16	
Pulsed Drain Current (Note 2)		I_{DM}	7.4	A
Total Power Dissipation @ T_C = 25°C		P_{DTOT}	77	W
Single Pulse Avalanche Energy (Note 3)		E_{AS}	20	mJ
Single Pulse Avalanche Current (Note 3)		I_{AS}	1.4	A
Operating Junction and Storage Temperature Range		T_J, T_{STG}	- 55 to +150	°C

THERMAL PERFORMANCE

PARAMETER	SYMBOL	Limit	UNIT
Junction to Case Thermal Resistance	$R_{\Theta JC}$	1.62	°C/W
Junction to Ambient Thermal Resistance	$R_{\Theta JA}$	62	°C/W

Thermal Performance Note: $R_{\Theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistances. The case-thermal reference is defined at the solder mounting surface of the drain pins. $R_{\Theta JA}$ is guaranteed by design while $R_{\Theta CA}$ is determined by the user's board design. $R_{\Theta JA}$ shown below for single device operation on FR-4 PCB in still air.

ELECTRICAL SPECIFICATIONS (T_A = 25°C unless otherwise noted)						
PARAMETER	**CONDITIONS**	**SYMBOL**	**MIN**	**TYP**	**MAX**	**UNIT**
Static						
Drain-Source Breakdown Voltage	V_{GS} = 0V, I_D = 250μA	BV_{DSS}	1000	--	--	V
Gate Threshold Voltage	V_{DS} = V_{GS}, I_D = 250μA	$V_{GS(TH)}$	3.5	4.5	5.5	V
Gate Body Leakage	V_{GS} = ±30V, V_{DS} = 0V	I_{GSS}	--	--	±100	nA
Zero Gate Voltage Drain Current	V_{DS} = 1000V, V_{GS} = 0V	I_{DSS}	--	--	1	μA
Drain-Source On-State Resistance (Note 4)	V_{GS} = 10V, I_D = 0.9A	$R_{DS(on)}$	--	6	8.5	Ω
Dynamic (Note 5)						
Total Gate Charge	V_{DS} = 800V, I_D = 1.85A, V_{GS} = 10V	Q_g	--	17	--	nC
Gate-Source Charge		Q_{gs}	--	5	--	
Gate-Drain Charge		Q_{gd}	--	9	--	
Input Capacitance	V_{DS} = 25V, V_{GS} = 0V, f = 1.0MHz	C_{iss}	--	625	--	pF
Output Capacitance		C_{oss}	--	38	--	
Reverse Transfer Capacitance		C_{rss}		15		
Gate Resistance	f = 1.0MHz, open drain	R_g	--	2.2	--	Ω
Switching (Note 6)						
Turn-On Delay Time	V_{DD} = 500V, R_G = 25Ω, I_D = 0.9A, V_{GS} = 10V	$t_{d(on)}$	--	31	--	ns
Turn-On Rise Time		t_r	--	14	--	
Turn-Off Delay Time		$t_{d(off)}$	--	78	--	
Turn-Off Fall Time		t_f	--	44	--	
Source-Drain Diode						
Forward Voltage (Note 4)	I_S = 1.85A, V_{GS} = 0V	V_{SD}	--	--	1.4	V
Reverse Recovery Time	V_R = 100V, I_S = 1.85A dI$_F$/dt = 100A/μs	t_{rr}	--	359	--	ns
Reverse Recovery Charge		Q_{rr}	--	1.34	--	μC

Notes:

1. Current limited by package
2. Pulse width limited by the maximum junction temperature
3. L = 20mH, I_{AS} = 1.4A, V_{DD} = 50V, R_G = 25Ω, Starting T_J = 25°C
4. Pulse test: PW ≤ 300μs, duty cycle ≤ 2%
5. For DESIGN AID ONLY, not subject to production testing.
6. Switching time is essentially independent of operating temperature.

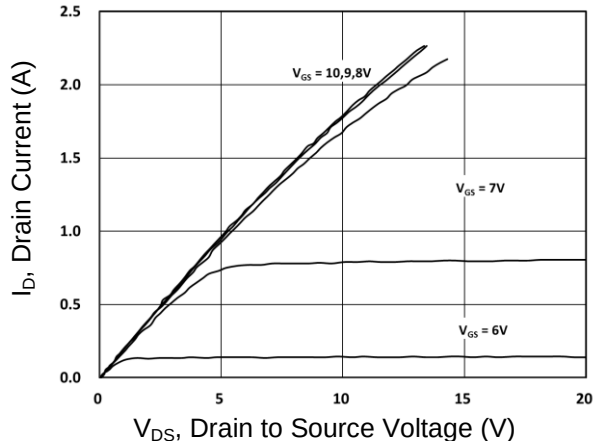
ORDERING INFORMATION

PART NO.	PACKAGE	PACKING
TSM2N100CH C5G	TO-251 (IPAK)	75pcs / Tube

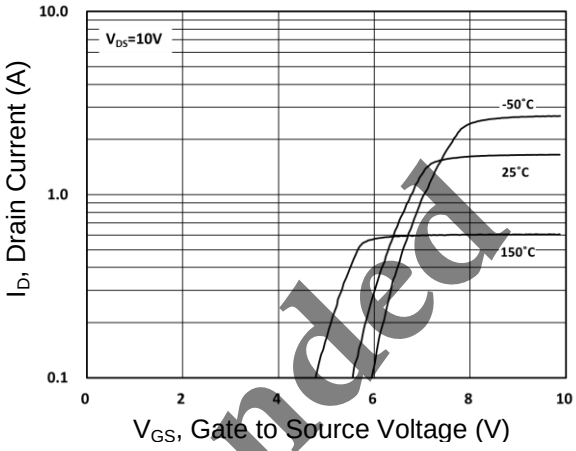
CHARACTERISTICS CURVES

(T_C = 25°C unless otherwise noted)

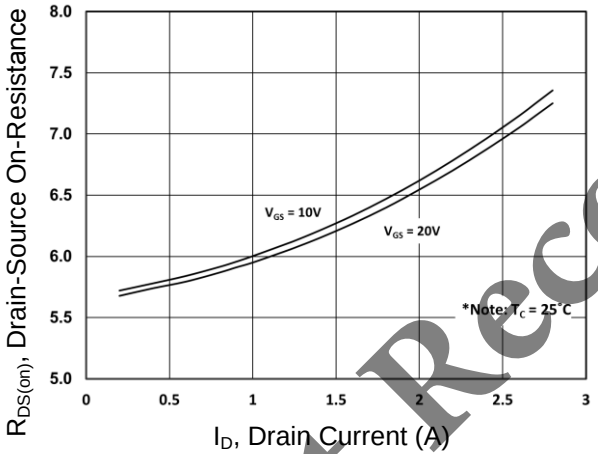
Output Characteristics



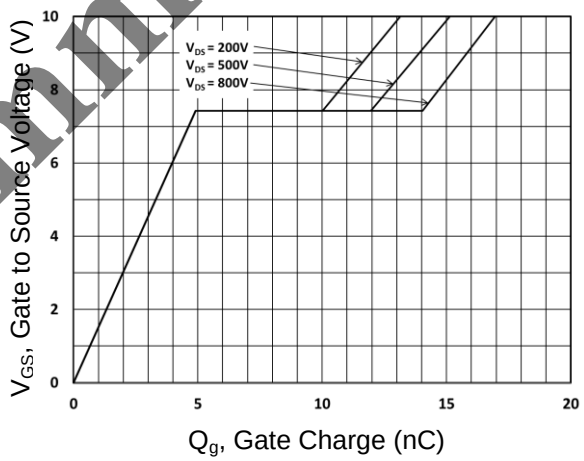
Transfer Characteristics



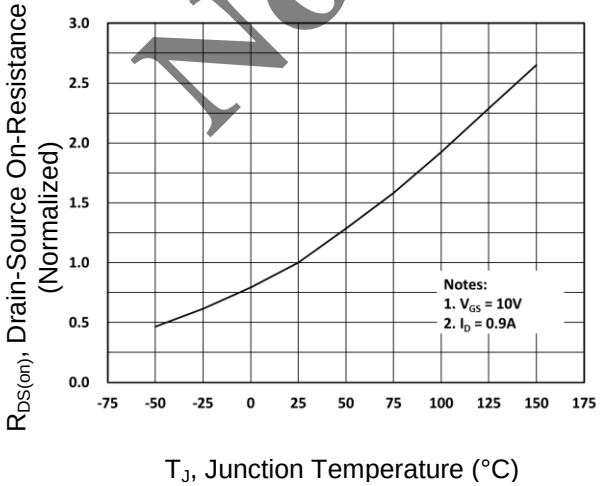
On-Resistance vs. Drain Current



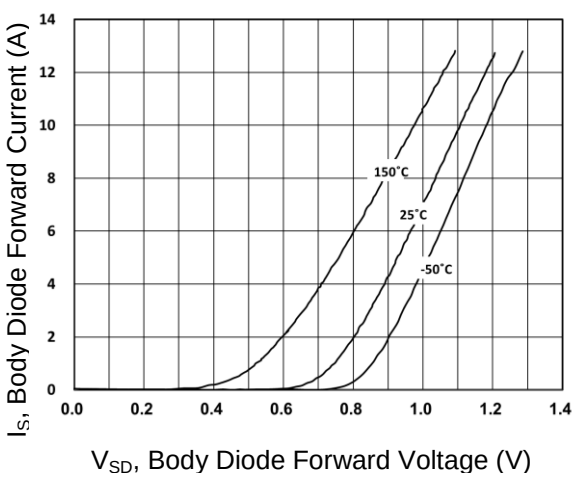
Gate-Source Voltage vs. Gate Charge



On-Resistance vs. Junction Temperature



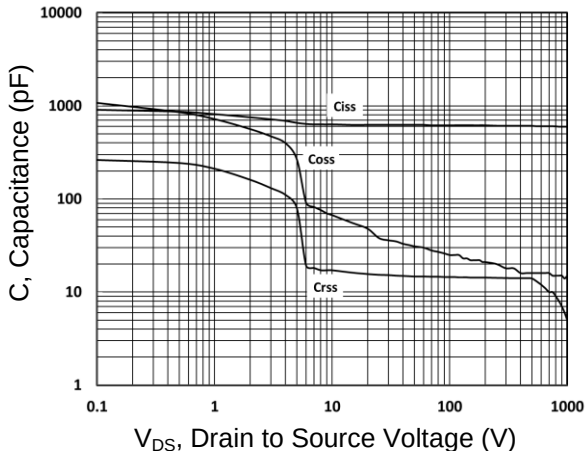
Source-Drain Diode Forward Current vs. Voltage



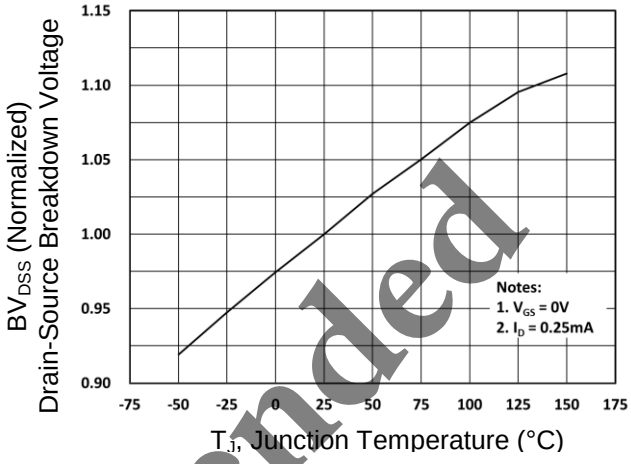
CHARACTERISTICS CURVES

(T_C = 25°C unless otherwise noted)

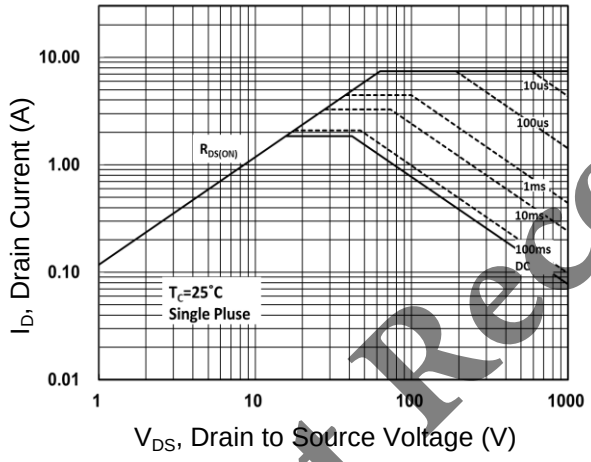
Capacitance vs. Drain-Source Voltage



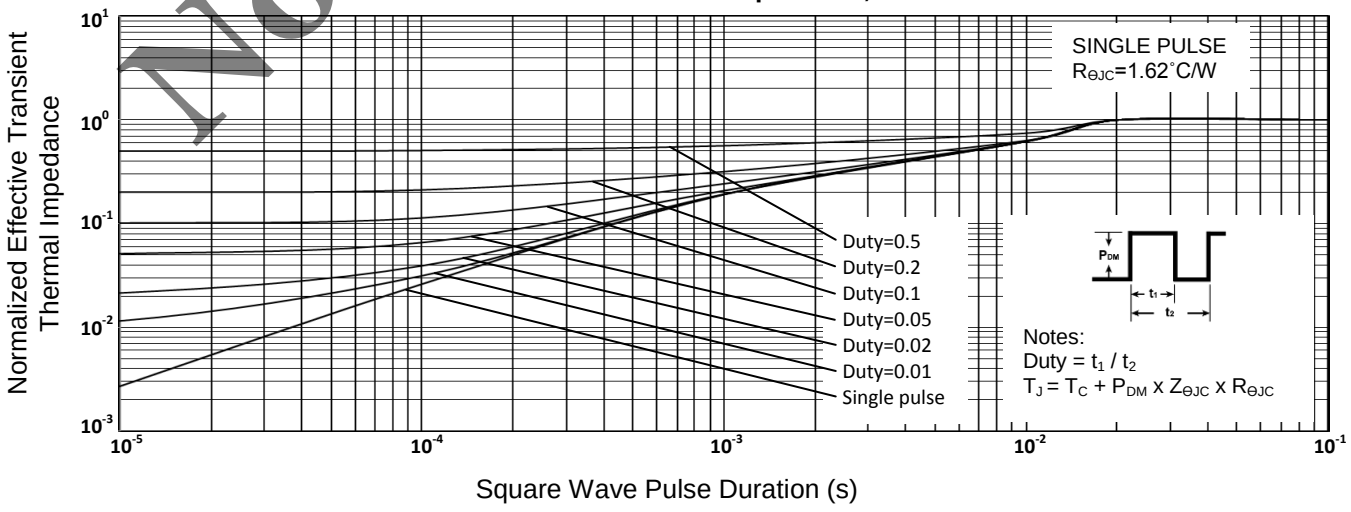
BV_{DSS} vs. Junction Temperature



Maximum Safe Operating Area

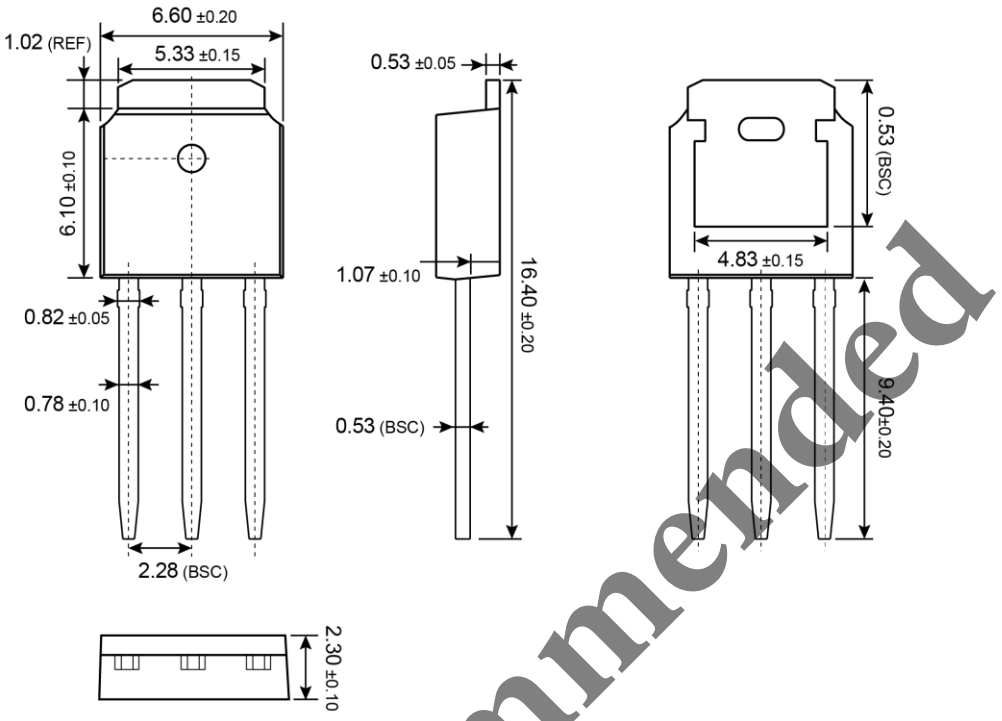


Normalized Thermal Transient Impedance, Junction-to-Case

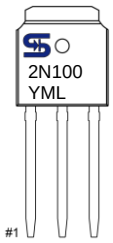


PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)

TO-251



MARKING DIAGRAM



Y = Year Code

M = Month Code

O =Jan	**P** =Feb	**Q** =Mar	**R** =Apr
S =May	**T** =Jun	**U** =Jul	**V** =Aug
W =Sep	**X** =Oct	**Y** =Nov	**Z** =Dec

L = Lot Code (1~9, A~Z)

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